
HD74HC668/HD74HC669

Synchronous UP/Down Decade Counter
Synchronous Up/Down 4-bit binary Counter

HITACHI

Description

This synchronous presettable decade counter features an internal carry look-ahead for cascading in high-speed counting applications. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the count-enable inputs and internal gating. This mode of operation helps eliminate the output counting spikes that are normally associated with asynchronous (ripple-clock) counters.

A buffered clock input triggers the four master-slave flip-flops on the rising (positive going) edge of the clock waveform. This counter is fully programmable; that is, the outputs may each be preset to either level. The load input circuitry allows loading with the carry-enable output of cascaded counters. As loading is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the data inputs after the next clock pulse.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count enable inputs and a carry output. Both count enable inputs ($\bar{P}$ and $\bar{T}$) must be low to count. The direction of the count is determined by the level of the up/down input. When the input is high, the counter counts up; when low, it counts down. Input $\bar{T}$ is fed forward to enable the carry output. The carry output thus enabled will produce a low-level output pulse with a duration approximately equal to the high portion of the Q_A output when counting up and approximately equal to the low portion of the Q_A output when counting down. This low level overflow carry pulse can be used to enable successive cascaded stages. Transitions at the enable $\bar{P}$ or $\bar{T}$ inputs are allowed regardless of the level of the clock input. All inputs are diode-clamped to minimize transission-line effects, thereby simplifying system design. This counter features a fully independent clock circuit. Changes at control inputs (enable $\bar{P}$, Enable $\bar{T}$, load, up/down) that will modify the operating mode have no effect until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) will be dictated solely by the conditions meeting the stable setup and hold times.

Features

- High Speed Operation
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2$ to 6 V
- Low Input Current: 1 μ A max

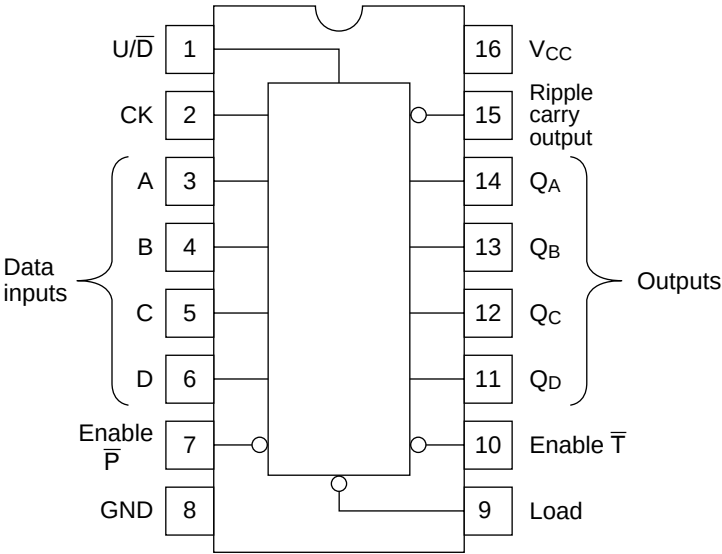


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- Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (T_a = 25°C)

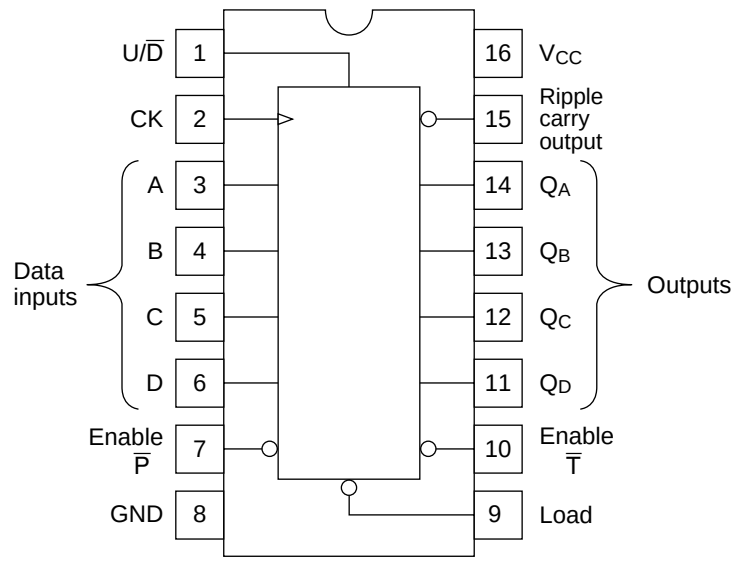
Pin Arrangement

HD74HC668



(Top view)

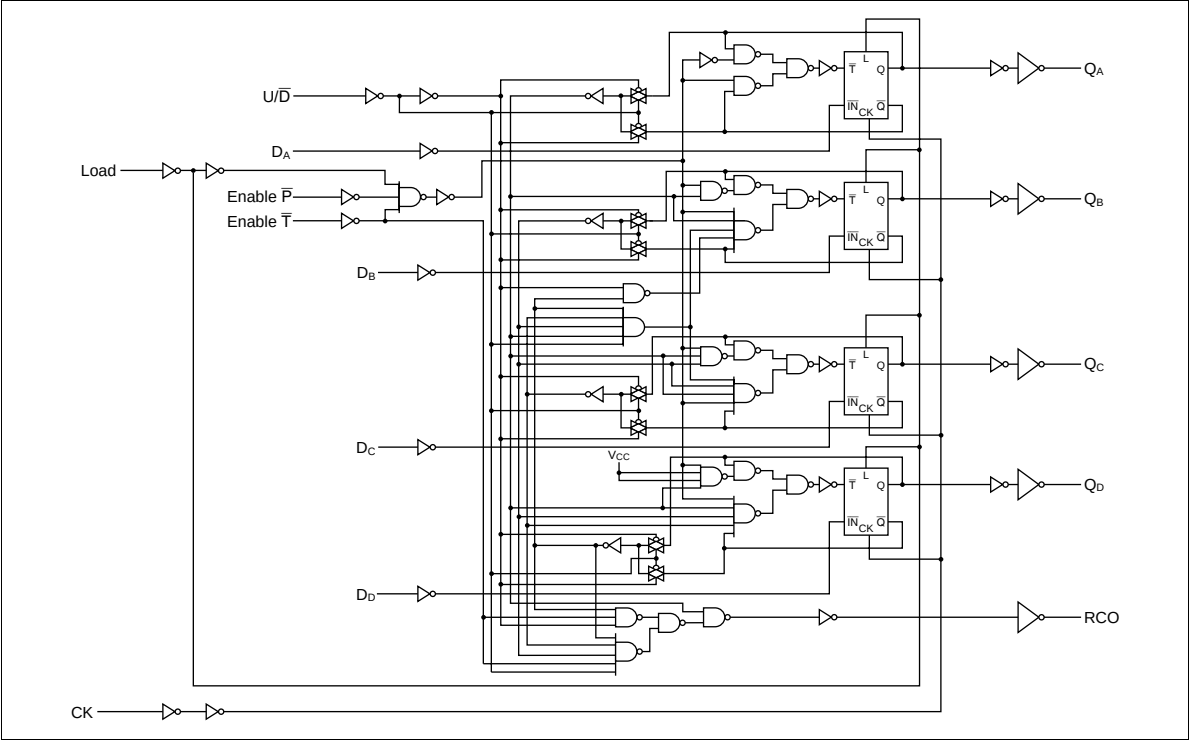
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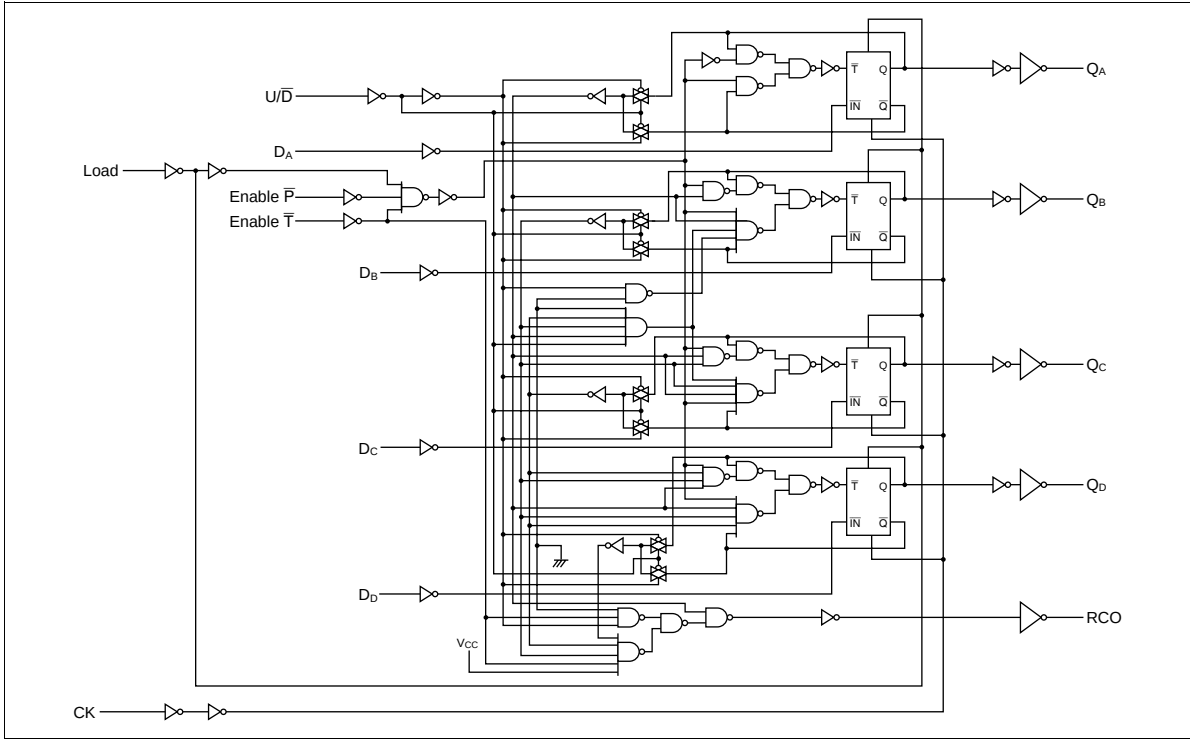
(Top view)

Logic Diagram

HD74HC668

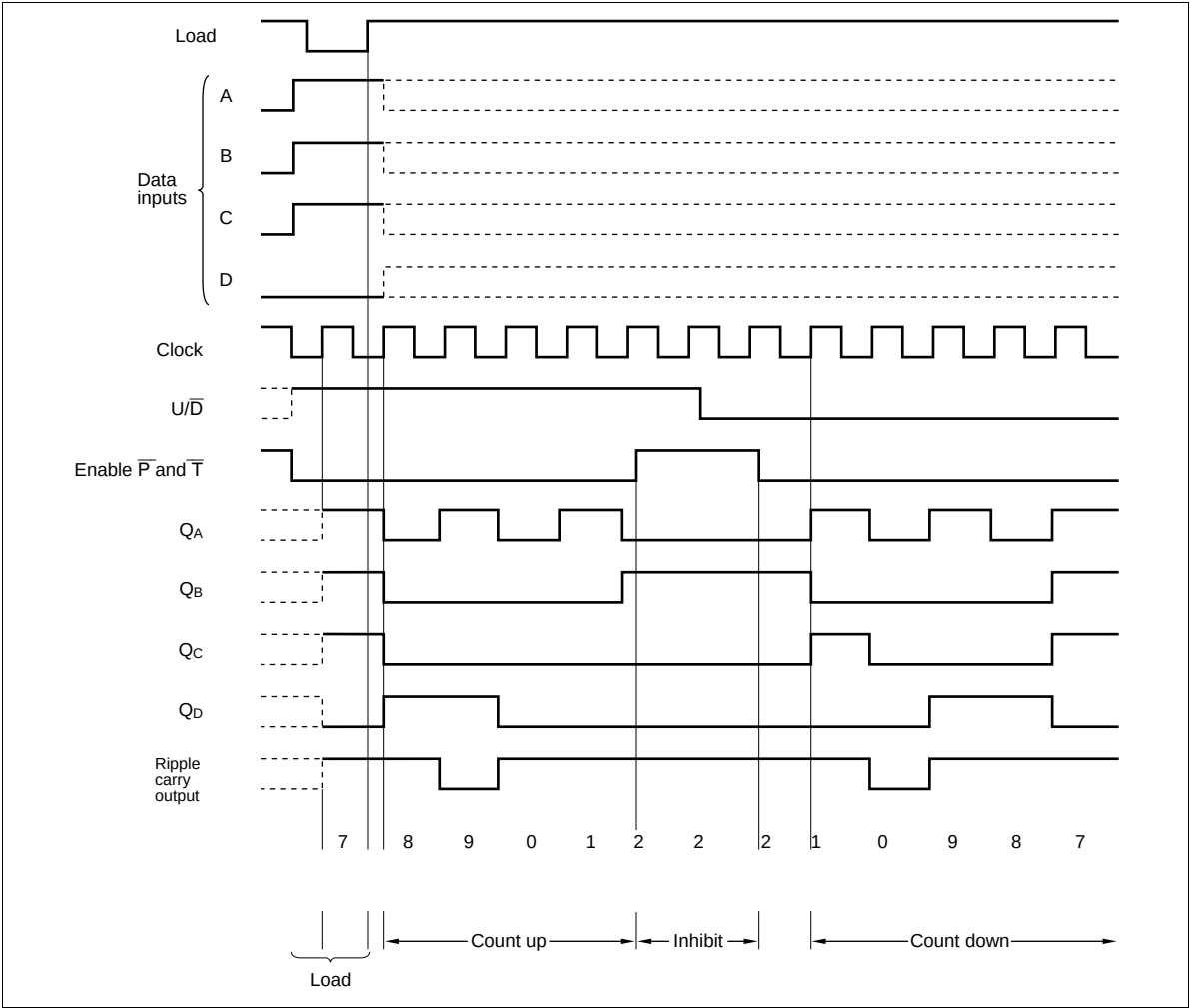


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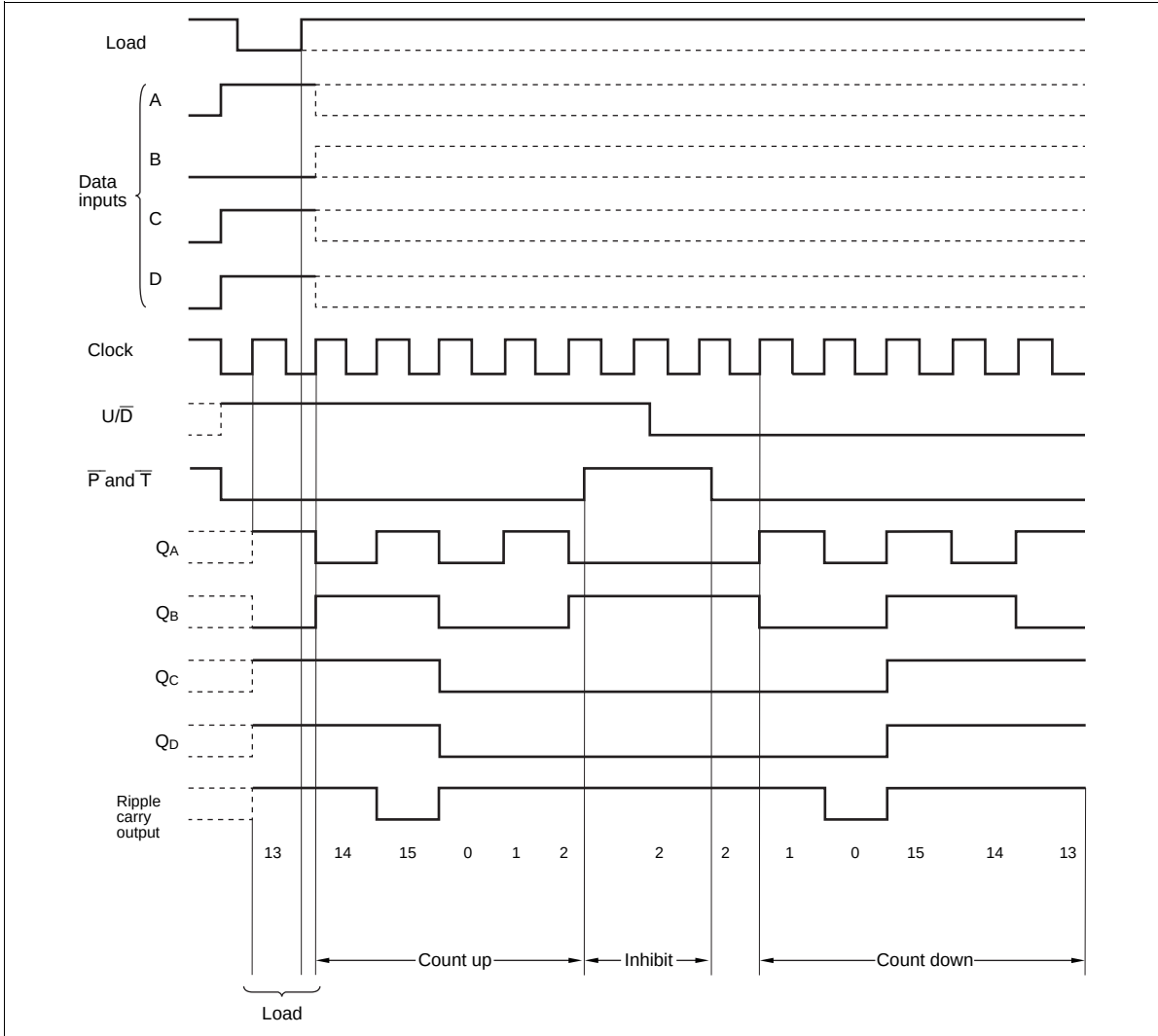


Timing Chart

HD74HC668



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DC Characteristics

Item	Symbol	V _{CC} (V)	Ta = 25°C			Ta = -40 to +85°C		Unit	Test Conditions	
			Min	Typ	Max	Min	Max			
Input voltage	V _{IH}	2.0	1.5	—	—	1.5	—	V		
		4.5	3.15	—	—	3.15	—			
		6.0	4.2	—	—	4.2	—			
	V _{IL}	2.0	—	—	0.5	—	0.5	V		
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
Output voltage	V _{OH}	2.0	1.9	2.0	—	1.9	—	V	Vin = V _{IH} or V _{IL} I _{OH} = -20 μA	
		4.5	4.4	4.5	—	4.4	—			
		6.0	5.9	6.0	—	5.9	—			
		4.5	4.18	—	—	4.13	—			I _{OH} = -4 mA
		6.0	5.68	—	—	5.63	—			I _{OH} = -5.2 mA
	V _{OL}	2.0	—	0.0	0.1	—	0.1	V	Vin = V _{IH} or V _{IL} I _{OL} = 20 μA	
		4.5	—	0.0	0.1	—	0.1			
		6.0	—	0.0	0.1	—	0.1			
		4.5	—	—	0.26	—	0.33			I _{OL} = 4 mA
		6.0	—	—	0.26	—	0.33			I _{OL} = 5.2 mA
Input current	I _{in}	6.0	—	—	±0.1	—	±1.0	μA	Vin = V _{CC} or GND	
Quiescent supply current	I _{CC}	6.0	—	—	4.0	—	40	μA	Vin = V _{CC} or GND, I _{out} = 0 μA	

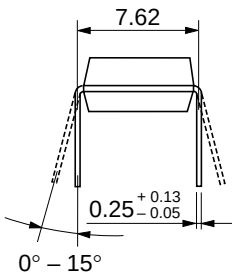
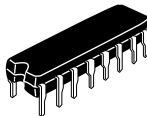
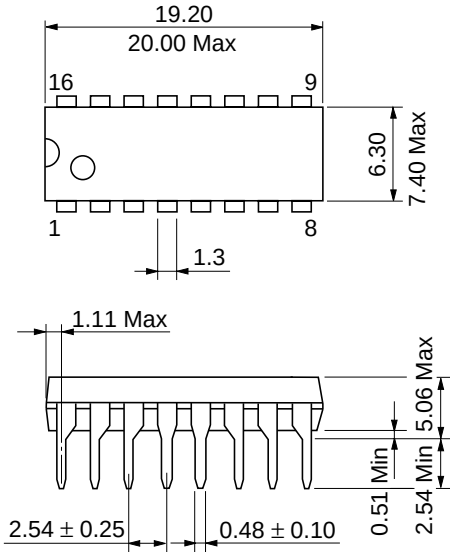
AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

Item	Symbol	$V_{CC} \text{ (V)}$	$T_a = 25^\circ\text{C}$			$T_a = -40 \text{ to } +85^\circ\text{C}$		Unit	Test Conditions
			Min	Typ	Max	Min	Max		
Maximum clock Frequency	$f_{\max}$	2.0	—	—	5	—	4	MHz	
		4.5	—	—	27	—	21		
		6.0	—	—	32	—	25		
Propagation delay time	t_{PLH}	2.0	—	—	200	—	250	ns	Clock to Ripple carry out
		4.5	—	—	40	—	50		
		6.0	—	—	34	—	43		
	t_{PHL}	2.0	—	—	225	—	280	ns	Clock to Q
		4.5	—	—	45	—	56		
		6.0	—	—	38	—	48		
	t_{PLH}	2.0	—	—	150	—	190	ns	Enable $\bar{T}$ to Ripple carry out
		4.5	—	—	30	—	38		
		6.0	—	—	26	—	33		
	t_{PHL}	2.0	—	—	200	—	250	ns	$U/\bar{D}$ to Ripple carry out
		4.5	—	—	40	—	50		
		6.0	—	—	34	—	43		
Pulse width	t_w	2.0	80	—	—	100	—	ns	
		4.5	16	—	—	20	—		
		6.0	14	—	—	17	—		
Setup time	t_{su}	2.0	100	—	—	125	—	ns	Data to Clock
		4.5	20	—	—	25	—		
		6.0	17	—	—	21	—		
	t_{su}	2.0	150	—	—	190	—	ns	Enable $\bar{P}$, $\bar{T}$ to Clock
		4.5	30	—	—	38	—		
		6.0	26	—	—	33	—		
	t_{su}	2.0	150	—	—	190	—	ns	Loadk to Clock
		4.5	30	—	—	38	—		
		6.0	26	—	—	33	—		
	t_{su}	2.0	150	—	—	190	—	ns	$U/\bar{D}$ to Clock
		4.5	30	—	—	38	—		
		6.0	26	—	—	33	—		

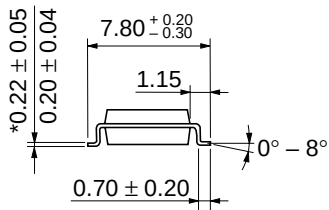
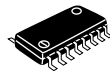
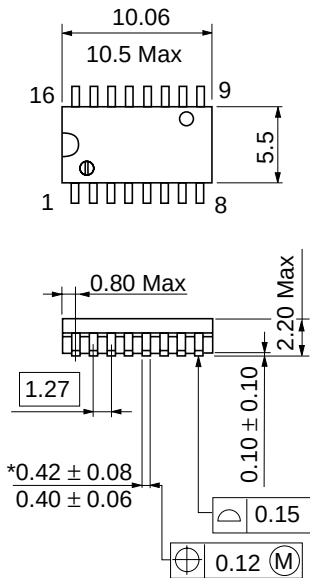
AC Characteristics (C_L = 50 pF, Input t_r = t_f = 6 ns) (cont)

Item	Symbol	V _{cc} (V)	Ta = -40 to +85°C					Unit	Test Conditions
			Ta = 25°C						
			Min	Typ	Max	Min	Max		
Hold time	t _h	2.0	5	—	—	5	—	ns	
		4.5	5	—	—	5	—		
		6.0	5	—	—	5	—		
Output rise/fall time	t _{TLH}	2.0	—	—	75	—	95	ns	
	t _{THL}	4.5	—	5	15	—	19		
		6.0	—	—	13	—	16		
Input capacitance	C _{in}	—	—	5	10	—	10	pF	

Unit: mm

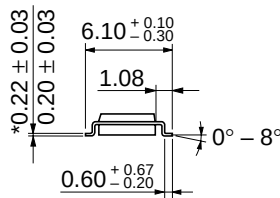
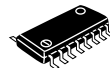
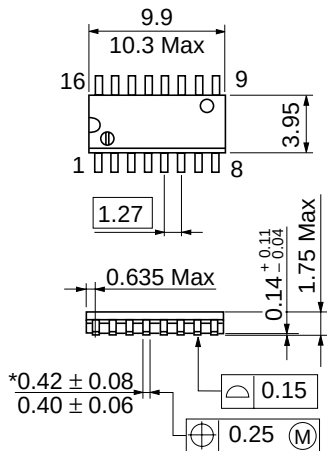


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JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g



*Dimension including the plating thickness
Base material dimension

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JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose, CA 95134 Tel: <1> (408) 433-1990 Fax: <1> (408) 433-0223	Hitachi Europe GmbH Electronic components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322
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Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533 Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180
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Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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